

SH273 Omni-polar Hall Effect Switch with Built-in Pull-up Resistor

SH273 is a medium sensitivity Hall effect switch designed in advanced DMOS technology. The following are integrated on a single silicon chip: voltage regulator, ESD protection, Hall voltage generator, chopper stabilized small-signal amplifier, Schmitt trigger, open-drain output and built-in pull-up resistor. Since the pull-up resistor is built, external pull-up resistor is not required. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization.

Features

- Medium Sensitivity
- Wide operating voltage (2.5~26V)
- Built-in pull-up resistor (10kΩ)
- Stable temperature characteristics
- Good ESD protection (HBM4kV min.)

Typical Applications

- Solid-state switch
- Lid close sensor for battery powered devices
- Water meter
- Floating meter

Ordering Information

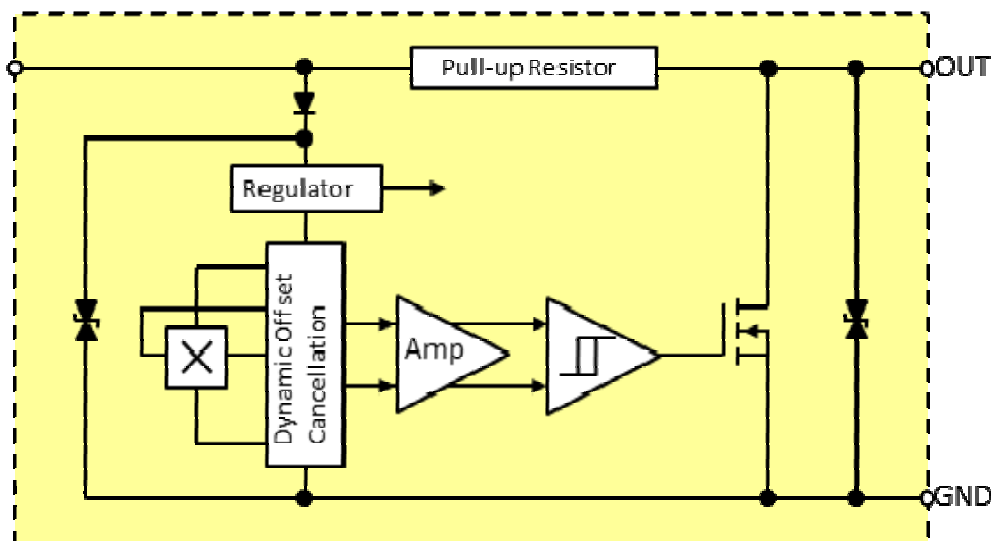
Model No.	Part No.	Temperature	Package	—	Packing
SH273KUA	SH273	K	UA		
SH273ESO-TR	SH273	E	SO	—	TR

Legend:

Temperature Code: E (-40°C~85°C), K (-40°C~125°C)

Package Code: UA (TO92S), SO (SOT23)

Packing Code: Brank (Balk, 500pcs/Bag), TR (Tape & Reel, 3,000pcs/Reel)

Functional Block Diagram


Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)

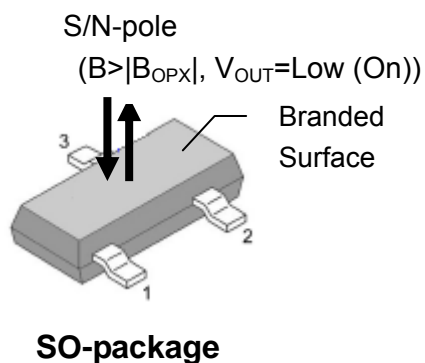
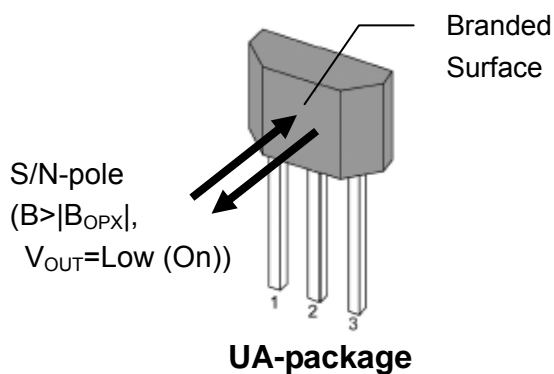
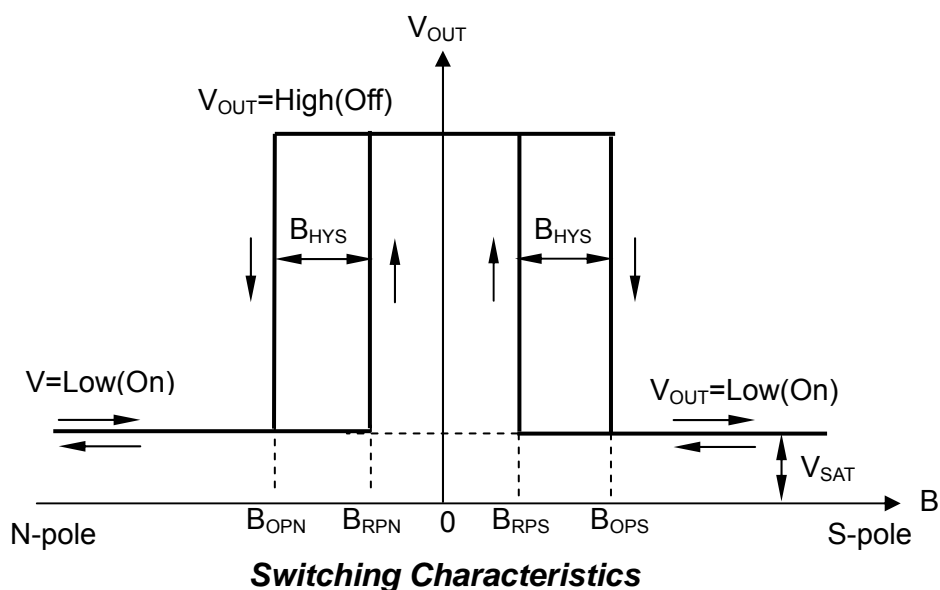
Parameter	Symbol	Value		Unit
		Min	Max	
Supply Voltage	V_{DD}	-0.3	28	V
Output Voltage	V_{OUT}	-0.3	28	V
Output Current	I_{SINK}	-	13	mA
Operating Temperature Range (E/K)	T_A	-40	85/125	$^\circ\text{C}$
Storage Temperature Range	T_S	-65	150	$^\circ\text{C}$
Maximum Junction Temperature	T_J		150	$^\circ\text{C}$
Power Dissipation (UA/SO)	P_D		606/230	mW

Electrical Characteristics ($T_A=25^\circ\text{C}$, $V_{DD}=12\text{V}$)

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Supply Voltage		V_{DD}	2.5	-	26	V
Consumption Current	$V_{OUT}=\text{High}$	I_{DD}	-	-	5	mA
Output Saturation Voltage	$V_{OUT}=\text{Low}$	V_{SAT}	-	0.3	0.5	V
Output Leakage Current	$V_{OUT}=\text{High (20V)}$	I_{LEAK}	-	-	10	μA
Power-on Time		t_{on}	-	-	50	μs
Delay Time		t_d	-	-	150	μs
Output Rise time	$R_L=1\text{k}\Omega$, $C_L=20\text{pF}$	t_R	-	0.04	0.45	μs
Output Fall time	$R_L=1\text{k}\Omega$, $C_L=20\text{pF}$	t_F	-	0.18	0.45	μs
Built-in Pull-up Resistor		R_P		10		$\text{k}\Omega$
Electro-Static Discharge	HBM		4	-	-	kV

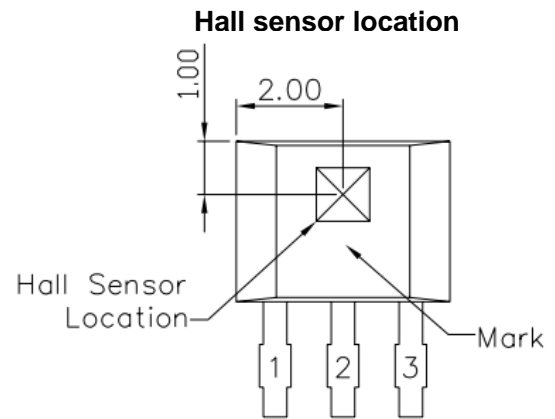
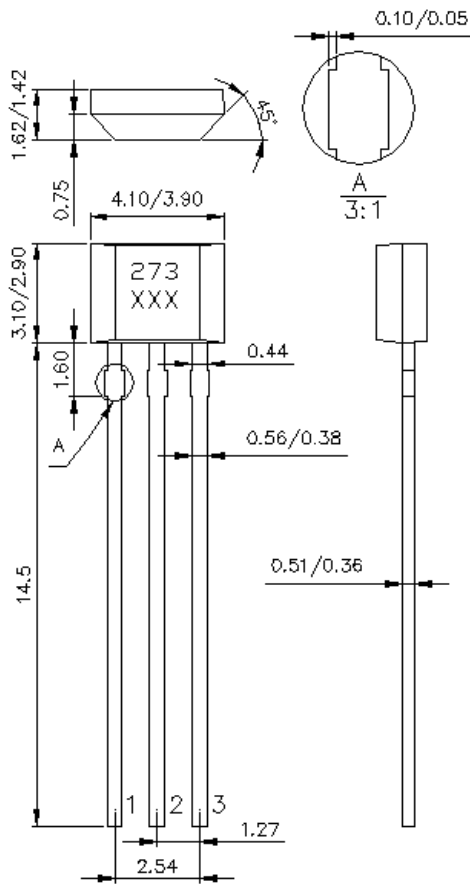
Magnetic Characteristics ($T_A=25^\circ\text{C}$, $V_{DD}=12\text{V}$)

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Operate Point	S pole to branded side	B_{OPS}	5	-	11	mT
	N pole to branded side	B_{OPN}	-11	-	-5	mT
Release Point	S pole to branded side	B_{RPS}	3	-	9	mT
	N pole to branded side	B_{RPN}	-9	-	-3	mT
Hysteresis	$ B_{OPX} - B_{RPX} $	B_{HYS}	-	2	-	mT



Sensor Location, Package Dimension and Marking

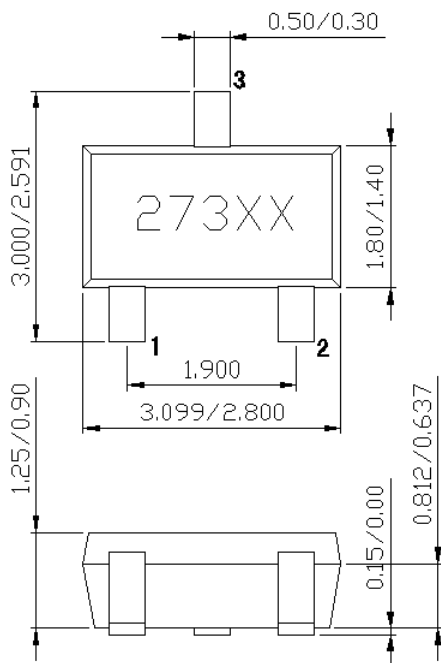
UA-package: T092S



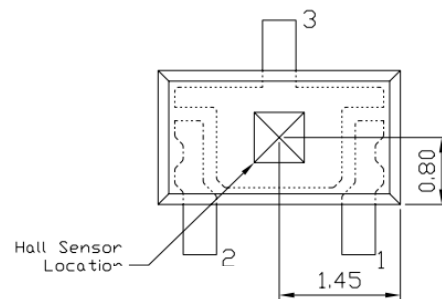
NOTES:

1. Controlling dimension: mm;
2. Leads must be free of flash and plating voids
3. Do not bend leads within 1 mm of lead to package interface
4. PINOUT:
 Pin 1 V_{DD}
 Pin 2 GND
 Pin 3 Output

SO-package: SOT23
(Upper View)



Hall sensor location
(Bottom View)



NOTES:

1. PINOUT:
 Pin 1 V_{DD}
 Pin 2 Output
 Pin 3 GND
2. Controlling dimension: mm;
3. Lead thickness after solder plating will be 0.254mm maximum.